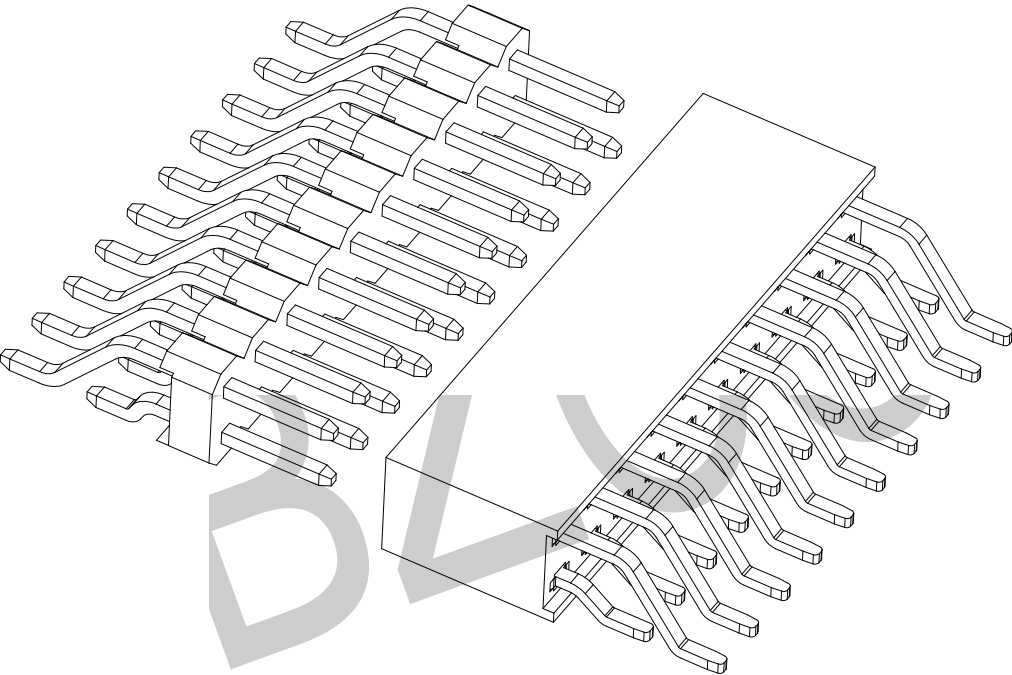




技术参数/Technical parameters

额定电流/Current Rating :2AMP  
 绝缘阻抗/Insulator Resistance :1000MΩ Min.  
 接触阻抗/Contact Resistance :20mΩ Max.  
 耐电压值/Voltage Resistance :AC 500V  
 工作温度/Operating Temperature :-40℃ ~ +105℃  
 金属材料/Metallic Material :Copper alloy  
 金属处理/Metal Treatment :Ni (30~50u") +See description  
 绝缘材料/Insulator Material :PA6T/PA9T/LCP UL94V-0  
 耐焊接热/Resistance To Soldering Heat :260° C ±5° C 10S MAX



A0	FIRST RELEASE	Y.L	2019.06.21
REV.	ECN. NO.	APR.	DATE

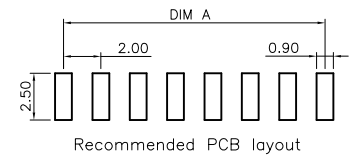
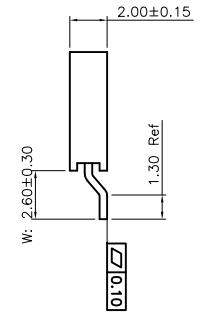
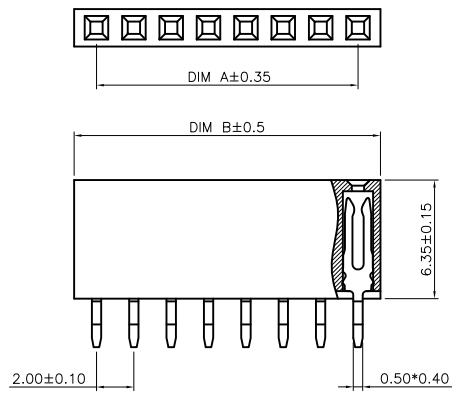
TOLERANCE UNLESS OTHERWISE SPECIFIED		东莞市柏洲电子有限公司 Dongguan BzooC Electronics, Ltd	
.X± 0.35	X.*± 1.5*	APR. AX.T	TITLE: PH2.0 SMT 90° SMT HEADER TYPE
.XX± 0.25	.X*± 1.0*	CHK. Y.L	PART NO.
.XXX± 0.15	.XX*± 0.5*	DRA. Y.L	PROJ.  UNITS. MM SCALE. 1:1 CUSTOMER DRAWING SHEET. 1/1



技术参数/Technical parameters

额定电流/Current Rating	:2AMP
绝缘阻抗/Insulator Resistance	:1000MΩ Min.
接触阻抗/Contact Resistance	:20mΩ Max.
耐电压值/Voltage Resistance	:AC 500V
工作温度/Operating Temperature	:-40°C ~ +105°C
金属材料/Metallic Material	:Copper alloy
金属处理/Metal Treatment	:Ni(30~50u")+Au
绝缘材料/Insulator Material	:PA6T/PA9T/LCP UL94V-0
耐焊接热/Resistance To Soldering Heat	:260° C ±5° C 10S MAX

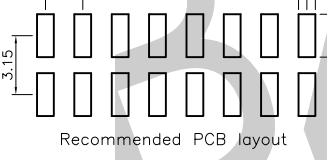
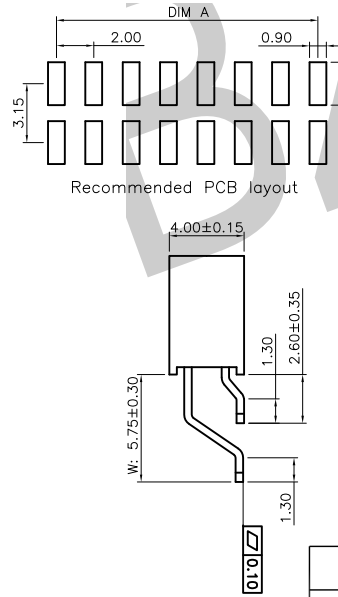
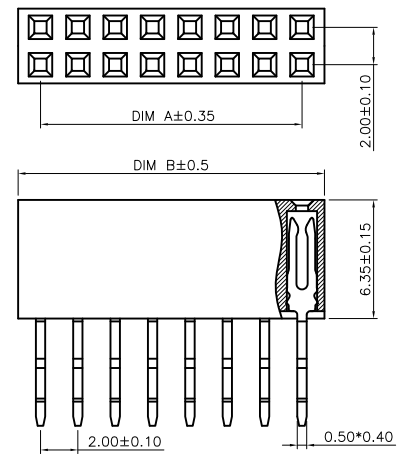
PER ROW PIN NO.	DIM A	DIM B	PER ROW PIN NO.	DIM A	DIM B
2p	2.00	4.40	21p	40.00	42.40
3p	4.00	6.40	22p	42.00	44.40
4p	6.00	8.40	23p	44.00	46.40
5p	8.00	10.40	24p	46.00	48.40
6p	10.00	12.40	25p	48.00	50.40
7p	12.00	14.40	26p	50.00	52.40
8p	14.00	16.40	27p	52.00	54.40
9p	16.00	18.40	28p	54.00	56.40
10p	18.00	20.40	29p	56.00	58.40
11p	20.00	22.40	30p	58.00	60.40
12p	22.00	24.40	31p	60.00	62.40
13p	24.00	26.40	32p	62.00	64.40
14p	26.00	28.40	33p	64.00	66.40
15p	28.00	30.40	34p	66.00	68.40
16p	30.00	32.40	35p	68.00	70.40
17p	32.00	34.40	36p	70.00	72.40
18p	34.00	36.40	37p	72.00	74.40
19p	36.00	38.40	38p	74.00	76.40
20p	38.00	40.40	39p	76.00	78.40
			40p	78.00	80.40



F 200-063-XXX-WRS-GF-X-X-Y26-000

排母 — SERIAL NO.  
200: 间距2.0mm — Y型W: 2.6MM  
塑胶高度: — 包装方式  
063: 6.35mm — T: 管装  
PIN数: — R: 卷装  
102: 1\*2P — D: 盒装  
202: 2\*2p — 塑胶材质:  
205: 2\*5p — D: PA6T  
240: 2\*40p — E: PA9T  
F: LCP

电镀: —  
GF: 镀金  
G1: 镀金 1U"  
G5: 镀金 5U"  
G10: 镀金 10U"



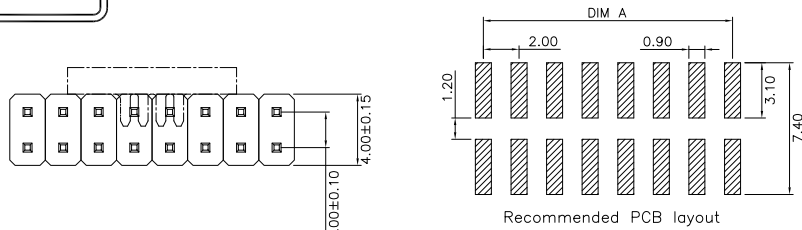
AO	FIRST RELEASE	Y.L	2019.06.21
REV.	ECN. NO.	APR.	DATE

TOLERANCE UNLESS OTHERWISE SPECIFIED		<b>BZOC</b> 东莞市柏洲电子有限公司 Dongguan Bzoc Electronics, Ltd	
.X± 0.35	.X*± 1.5'	APR. AX.T	TITLE: FH2.0*6.35 90° SMT FEMALE HEADER TYPE
.XX± 0.25	.X*± 1.0'	CHK. Y.L	PART NO.
.XXX± 0.15	.XX*± 0.5'	DRA. Y.L	PROJ.  UNITS. MM SCALE. 1:1 SHEET. 1 / 1
		CUSTOMER DRAWING	

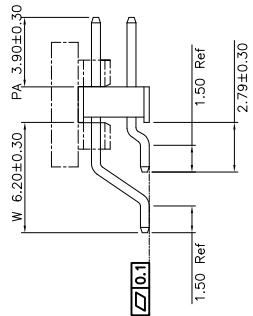
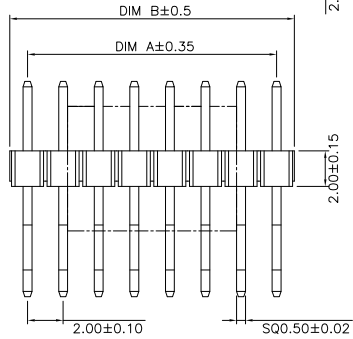


技术参数/Technical parameters

额定电流/Current Rating :2AMP  
 绝缘阻抗/Insulator Resistance :1000MΩ Min.  
 接触阻抗/Contact Resistance :20mΩ Max.  
 耐电压值/Voltage Resistance :AC 500V  
 工作温度/Operating Temperature :-40℃ ~ +105℃  
 金属材料/Metallic Material :Copper alloy  
 金属处理/Metal Treatment :Ni(30~50u")+See description  
 绝缘材料/Insulator Material :PA6T/PA9T/LCP UL94V-0  
 耐焊接热/Resistance To Soldering Heat :260° C ±5° C 10S MAX

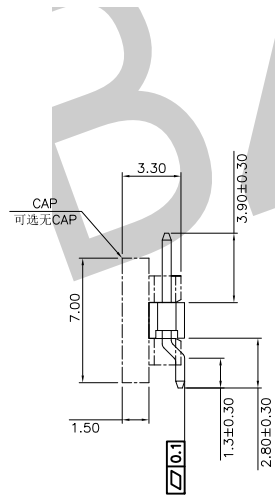
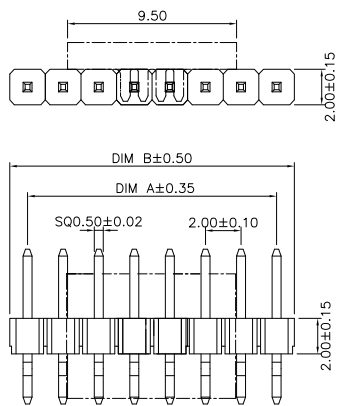


Recommended PCB layout

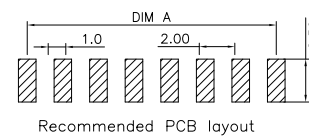


PER ROW PIN NO.	DIMA	DIM B
2P	2.00	4.00
3P	4.00	6.00
4P	6.00	8.00
5P	8.00	10.00
6P	10.00	12.00
7P	12.00	14.00
8P	14.00	16.00
9P	16.00	18.00
10P	18.00	20.00
11P	20.00	22.00
12P	22.00	24.00
13P	24.00	26.00
14P	26.00	28.00
15P	28.00	30.00
16P	30.00	32.00
17P	32.00	34.00
18P	34.00	36.00
19P	36.00	38.00
20P	38.00	40.00

PER ROW PIN NO.	DIMA	DIM B
21P	40.00	42.00
22P	42.00	44.00
23P	44.00	46.00
24P	46.00	48.00
25P	48.00	50.00
26P	50.00	52.00
27P	52.00	54.00
28P	54.00	56.00
29P	56.00	58.00
30P	58.00	60.00
31P	60.00	62.00
32P	62.00	64.00
33P	64.00	66.00
34P	66.00	68.00
35P	68.00	70.00
36P	70.00	72.00
37P	72.00	74.00
38P	74.00	76.00
39P	76.00	78.00
40P	78.00	80.00



**P 200-020-XXX-WRS-GF-X-X-XXX-XXX-XXX-000**  
 Pin Header  
 Pitch:2.0mm  
 塑胶高度:  
 020:2.0mm  
 101:1\*1P  
 201:2\*1P  
 202:2\*2P  
 ...  
 240:2\*40P 卧贴  
 serial No.  
 PA size (039:3.9mm)  
 W size (062:62mm)  
 PIN L (082: 8.2mm)  
 包装方式  
 T: 管装  
 R: 卷装  
 D: 盒装  
 TC:管装+CAP  
 RC:卷装+CAP  
 电镀:  
 GF:镀金  
 G1:镀金 1U"  
 G5:镀金 5U"  
 SN:镀锡  
 塑胶材质:  
 D:PA6T  
 E:PA9T  
 F:LCP



Recommended PCB layout

A0	FIRST RELEASE	Y.L	2019.06.21
REV.	ECN. NO.	APR.	DATE

TOLERANCE UNLESS OTHERWISE SPECIFIED		<b>BZOC</b> 东莞市柏洲电子有限公司 Dongguan Bzoc Electronics, Ltd	
.X± 0.35	X.'± 1.5'	APR. AX.T	TITLE: PH2.0 SMT 90° SMT PIN HEADER TYPE
.XX± 0.25	.X'± 1.0'	CHK. Y.L	PART NO.
.XXX± 0.15	.XX'± 0.5'	DRA. Y.L	PROJ.
		UNITS. MM	SCALE: 1:1
		CUSTOMER DRAWING	
		SHEET. 1 / 1	